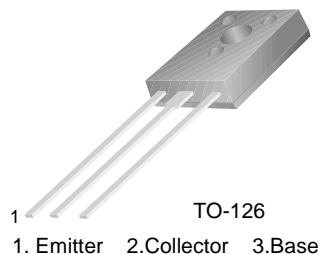


KSE700/701/702/703

Monolithic Construction With Built-in Base-Emitter Resistors

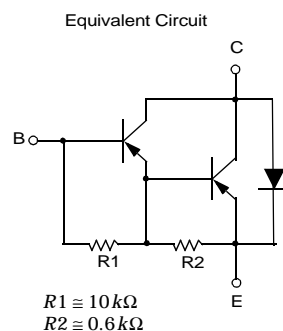
- High DC Current Gain : $h_{FE} = 750$ (Min.) @ $I_C = -1.5$ and -2.0 A DC
- Complement to KSE800/801/802/803



PNP Epitaxial Silicon Darlington Transistor

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector- Base Voltage : KSE700/701 : KSE702/703	- 60 - 80	V
V_{CEO}	Collector-Emitter Voltage : KSE700/701 : KSE702/703	- 60 - 80	V
V_{EBO}	Emitter- Base Voltage	- 5	V
I_C	Collector Current	- 4	A
I_B	Base Current	- 0.1	A
P_C	Collector Dissipation ($T_C = 25^\circ\text{C}$)	40	W
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature	- 55 ~ 150	$^\circ\text{C}$



Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
BV_{CEO}	Collector-Emitter Breakdown Voltage : KSE700/701 : KSE702/703	$I_C = -10\text{ mA}$, $I_B = 0$	-60 -80		V V
I_{CEO}	Collector Cut-off Current : KSE700/701 : KSE702/703	$V_{CE} = -60\text{ V}$, $I_B = 0$ $V_{CE} = -80\text{ V}$, $I_B = 0$		-100 -100	μA μA
I_{CBO}	Collector Cut-off Current	$V_{CB} = \text{Rated } BV_{CEO}$, $I_E = 0$ $V_{CB} = \text{Rated } BV_{CEO}$, $I_E = 0$ @ $T_C = 100^\circ\text{C}$		-100 -500	μA μA
I_{EBO}	Emitter Cut-off Current	$V_{BE} = -5\text{ V}$, $I_C = 0$		-2	mA
h_{FE}	DC Current Gain : KSE700/702 : KSE701/703 : ALL DEVICES	$V_{CE} = -3\text{ V}$, $I_C = -1.5\text{ A}$ $V_{CE} = -3\text{ V}$, $I_C = -2\text{ A}$ $V_{CE} = -3\text{ V}$, $I_C = -4\text{ A}$	750 750 100		
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage : KSE700/702 : KSE701/703 : ALL DEVICES	$I_C = -1.5\text{ A}$, $I_B = -30\text{ mA}$ $I_C = -2\text{ A}$, $I_B = -40\text{ mA}$ $I_C = -4\text{ A}$, $I_B = -40\text{ mA}$		-2.5 -2.8 -3	V V V
$V_{BE(on)}$	Base-Emitter On Voltage : KSE700/702 : KSE701/703 : ALL DEVICES	$V_{CE} = -3\text{ V}$, $I_C = -1.5\text{ A}$ $V_{CE} = -3\text{ V}$, $I_C = -2\text{ A}$ $V_{CE} = -3\text{ V}$, $I_C = -4\text{ A}$		-1.2 -2.5 -3	V V V

Typical Characteristics

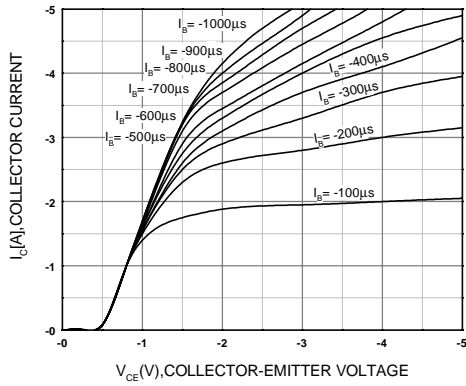


Figure 1. Static Characteristic

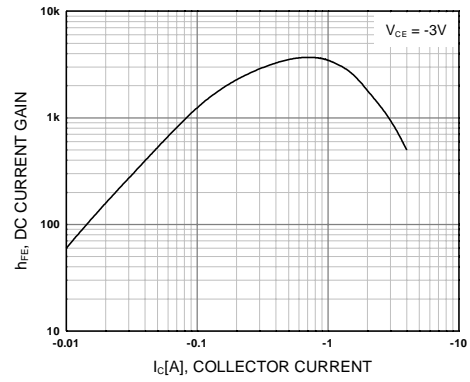


Figure 2. DC current Gain

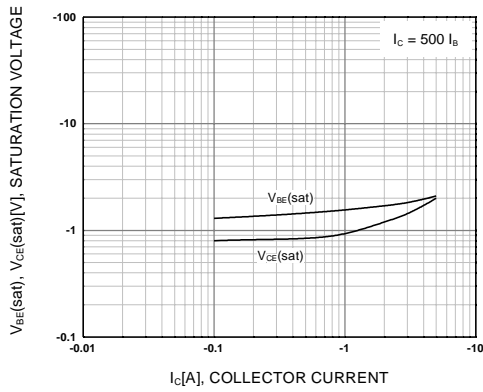


Figure 3. Collector-Emitter Saturation Voltage
Base-Emitter Saturation Voltage

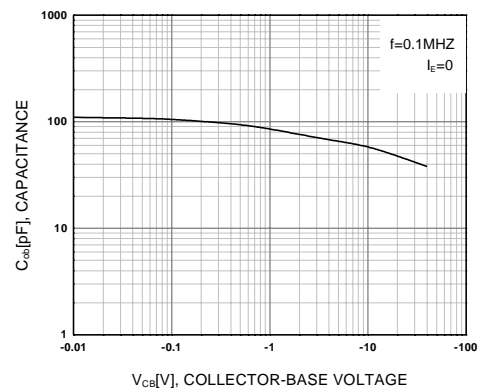


Figure 4. Collector Output Capacitance

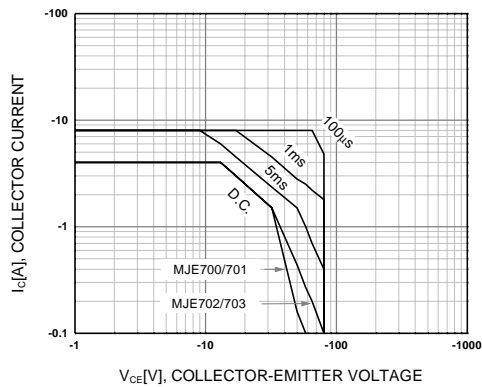


Figure 5. Safe Operating Area

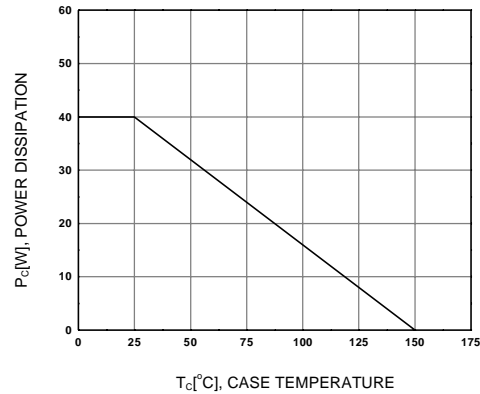
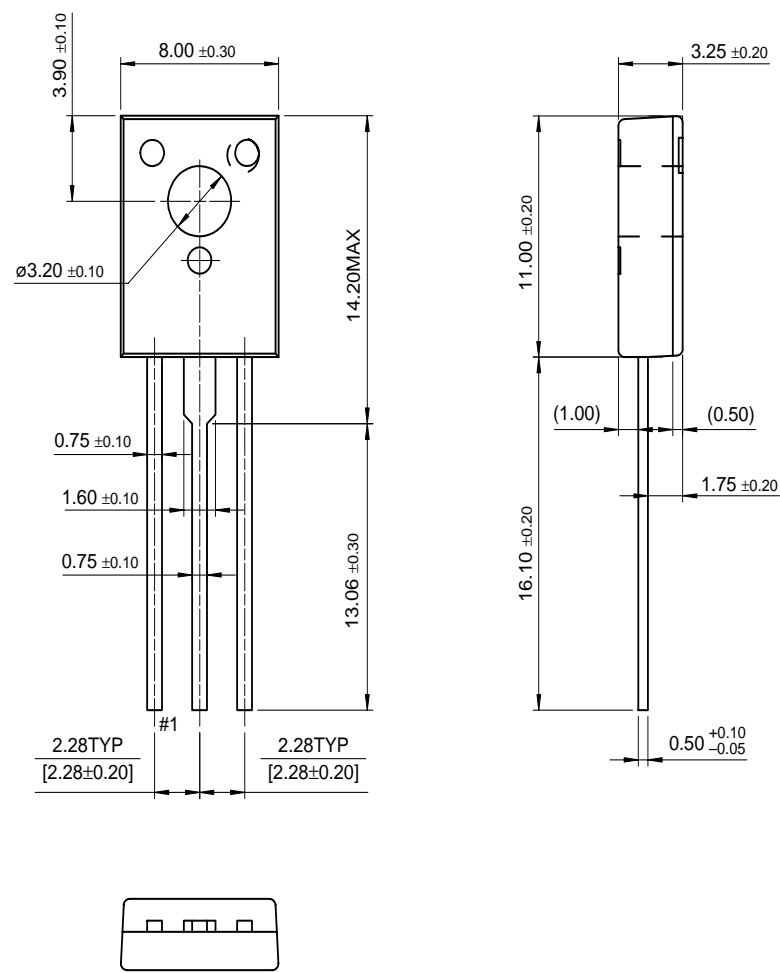


Figure 6. Power Derating

Package Dimensions

TO-126



Dimensions in Millimeters

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